

# SFH 4247

## Mini TOLED®

Infrared Emitter (940 nm)



## Applications

- Electronic Equipment
- Safety and Security, CCTV
- Industrial Automation (Machine Controls, Light Barriers, Vision Controls)

## Features:

- Package: clear epoxy
- Qualifications: The product qualification test plan is based on the guidelines of AEC-Q101-REV-C, Stress Test Qualification for Automotive Grade Discrete Semiconductors.
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)
- Wavelength 950nm
- Short switching times

## Ordering Information

Type	Radiant intensity <sup>1)</sup> $I_F = 70 \text{ mA}; t_p = 20 \text{ ms}$ $I_e$	Radiant intensity <sup>1)</sup> typ. $I_F = 70 \text{ mA}; t_p = 20 \text{ ms}$ $I_e$	Ordering Code
SFH 4247-Z	6.3 ... 32.0 mW/sr	12 mW/sr	Q65110A8091
SFH 4247-QR	6.3 ... 20.0 mW/sr	12 mW/sr	Q65112A4902

## Maximum Ratings

$T_A = 25 \text{ }^\circ\text{C}$

Parameter	Symbol	Values
Operating temperature	$T_{op}$	min. -40 °C max. 100 °C
Storage temperature	$T_{stg}$	min. -40 °C max. 100 °C
Reverse voltage <sup>2)</sup>	$V_R$	max. 12 V
Forward current	$I_F$	max. 70 mA
Surge current $t_p \leq 200 \mu\text{s}; D = 0$	$I_{FSM}$	max. 1 A
Power consumption	$P_{tot}$	max. 140 mW
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	$V_{ESD}$	max. 2 kV

## Characteristics

$I_F = 70 \text{ mA}$ ;  $t_p = 20 \text{ ms}$ ;  $T_A = 25^\circ\text{C}$

Parameter	Symbol	Values
Peak wavelength	$\lambda_{\text{peak}}$	typ. 950 nm
Centroid wavelength	$\lambda_{\text{centroid}}$	typ. 940 nm
Spectral bandwidth at 50% $I_{\text{rel,max}}$	$\Delta\lambda$	typ. 42 nm
Half angle	$\varphi$	typ. 65 °
Dimensions of active chip area	$L \times W$	typ. 0.3 x 0.3 mm x mm
Rise time (10% / 90%) $I_F = 70 \text{ mA}; R_L = 50 \Omega$	$t_r$	typ. 12 ns
Fall time (10% / 90%) $I_F = 70 \text{ mA}; R_L = 50 \Omega$	$t_f$	typ. 12 ns
Forward voltage	$V_F$	typ. 1.5 V max. 1.9 V
Forward voltage $I_F = 1 \text{ A}; t_p = 100 \mu\text{s}$	$V_F$	typ. 3.6 V max. 4.6 V
Reverse current <sup>2)</sup> $V_R = 5 \text{ V}$	$I_R$	max. 10 $\mu\text{A}$ typ. 0.01 $\mu\text{A}$
Total radiant flux <sup>3)</sup>	$\Phi_e$	typ. 40 mW
Radiant intensity <sup>1)</sup> $I_F = 500 \text{ mA}; t_p = 25 \mu\text{s}$	$I_e$	typ. 70 mW/sr
Temperature coefficient of brightness	$TC_I$	typ. -0.3 % / K
Temperature coefficient of voltage	$TC_V$	typ. -0.8 mV / K
Temperature coefficient of wavelength	$TC_\lambda$	typ. 0.3 nm / K
Thermal resistance junction ambient real <sup>4)</sup>	$R_{\text{thJA}}$	max. 390 K / W
Thermal resistance junction solder point real <sup>5)</sup>	$R_{\text{thJS}}$	max. 220 K / W

## Brightness Groups

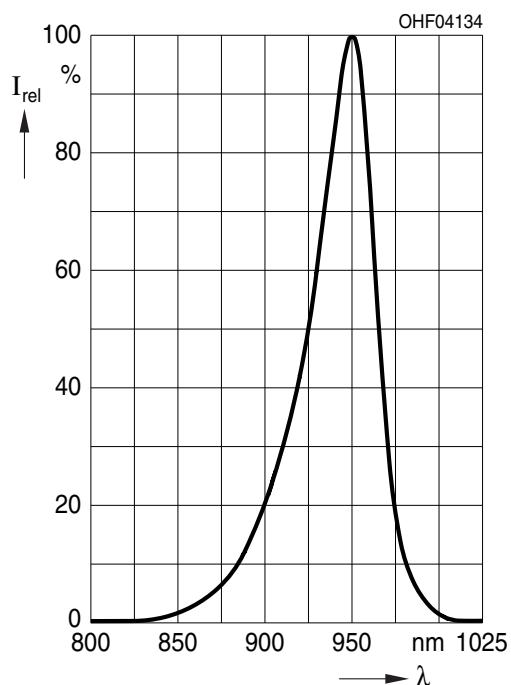
$T_A = 25^\circ\text{C}$

Group	Radiant intensity $I_F = 70 \text{ mA}; t_p = 20 \text{ ms}$ min. $I_e$	Radiant intensity $I_F = 70 \text{ mA}; t_p = 20 \text{ ms}$ max. $I_e$
Q	6.3 mW/sr	12.5 mW/sr
R	10.0 mW/sr	20.0 mW/sr
S	16.0 mW/sr	32.0 mW/sr

Only one group in one packing unit (variation lower 2:1).

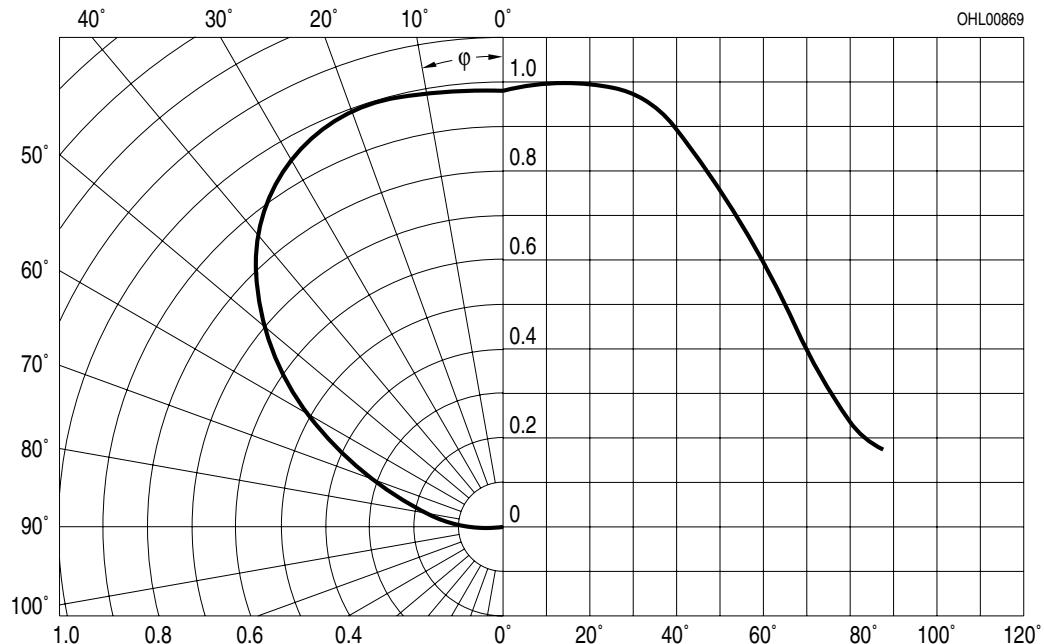
## Relative Spectral Emission <sup>6), 7)</sup>

$I_{\text{rel}} = f(\lambda); I_F = 70 \text{ mA}; t_p = 20 \text{ ms}$

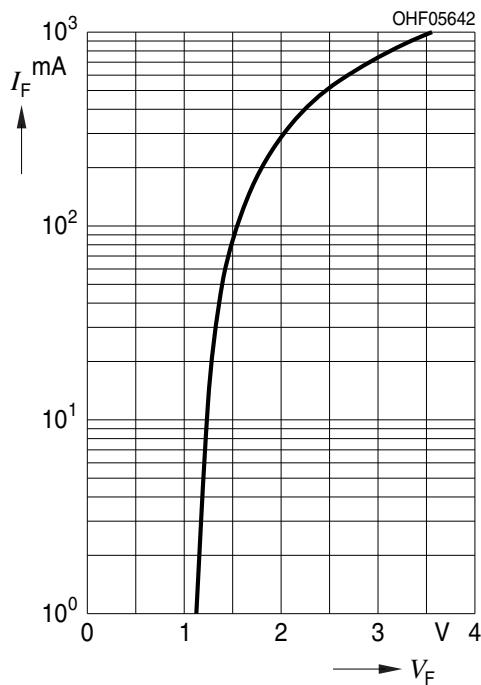


**Radiation Characteristics** <sup>6), 7)</sup>

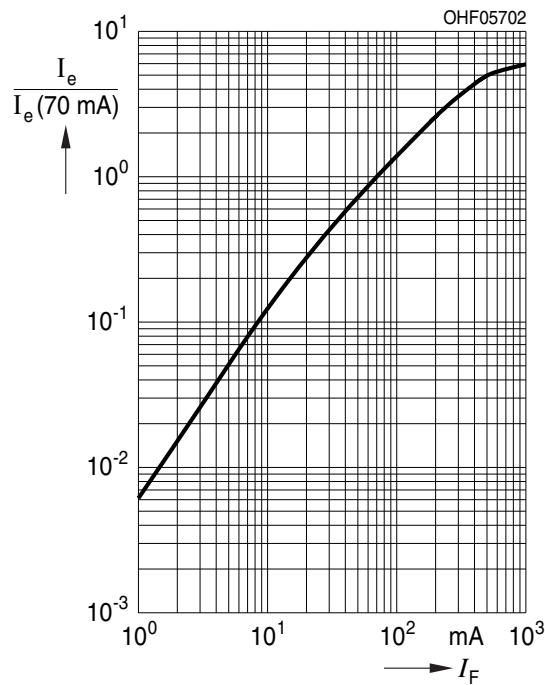
$$I_{\text{rel}} = f(\phi)$$

**Forward current** <sup>6), 7)</sup>

$$I_F = f(V_F); \text{ single pulse; } t_p = 100 \mu\text{s}$$

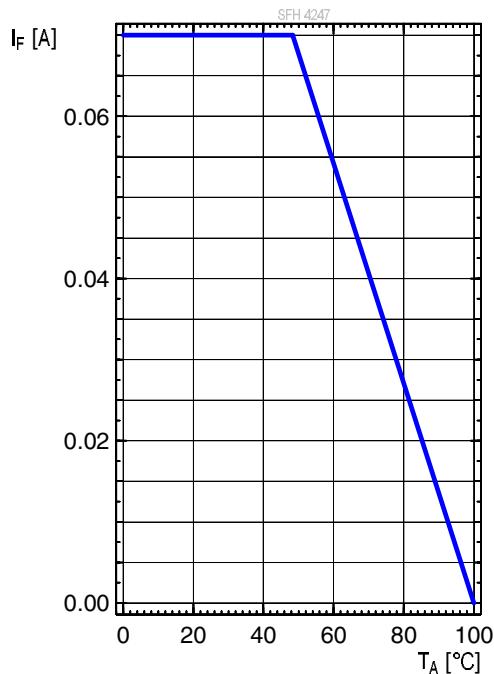
**Radiant Intensity** <sup>6), 7)</sup>

$$\frac{I_e}{I_e(70 \text{mA})} = f(I_F); \text{ single pulse; } t_p = 100 \mu\text{s}$$



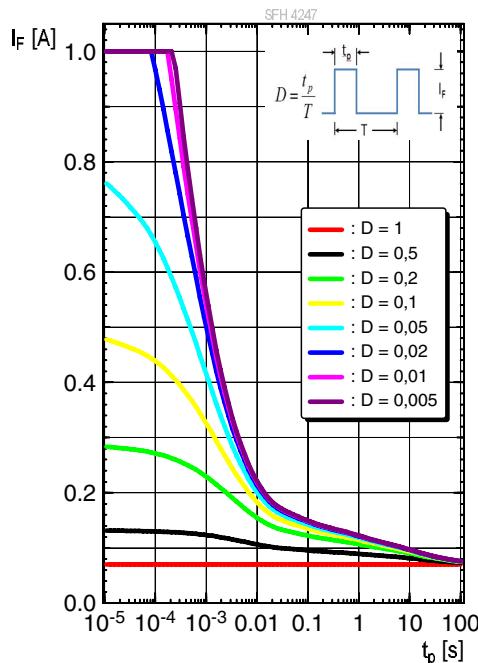
## Max. Permissible Forward Current

$$I_{F,\max} = f(T_A); R_{thJA} = 390 \text{ K / W}$$



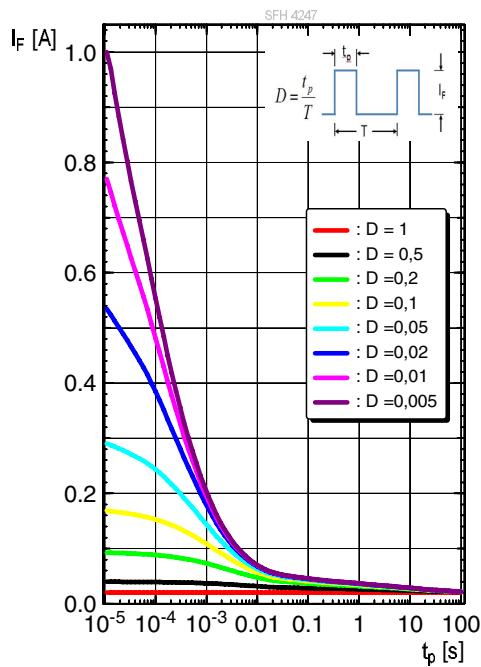
## Permissible Pulse Handling Capability

$$I_F = f(t_p); \text{duty cycle } D = \text{parameter}; T_A = 25^\circ\text{C}$$

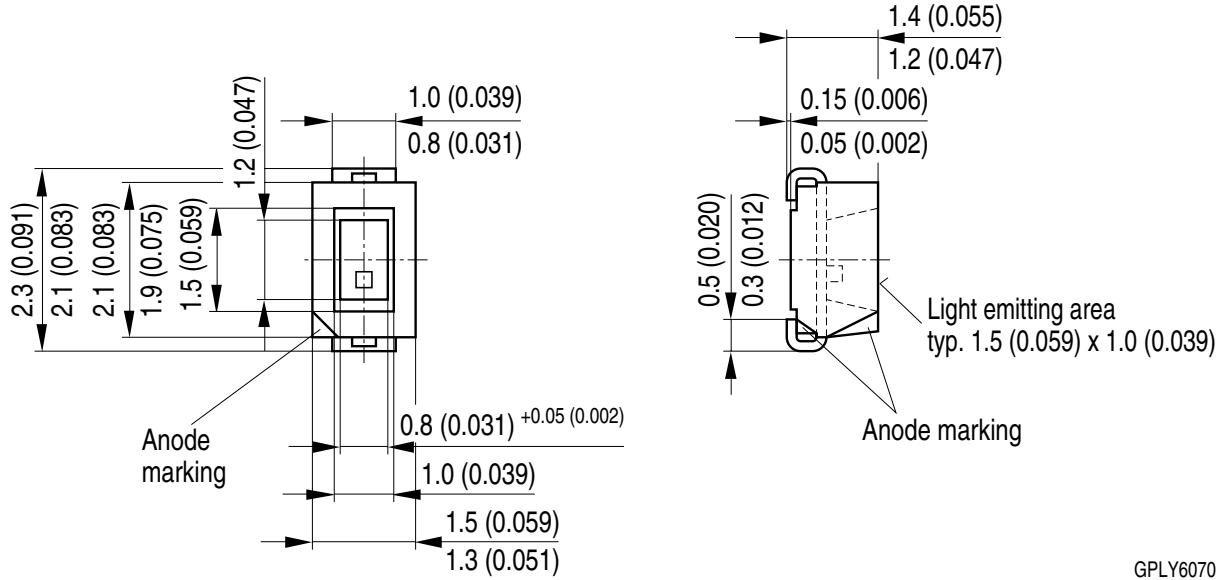


## Permissible Pulse Handling Capability

$$I_F = f(t_p); \text{duty cycle } D = \text{parameter}; T_A = 85^\circ\text{C}$$



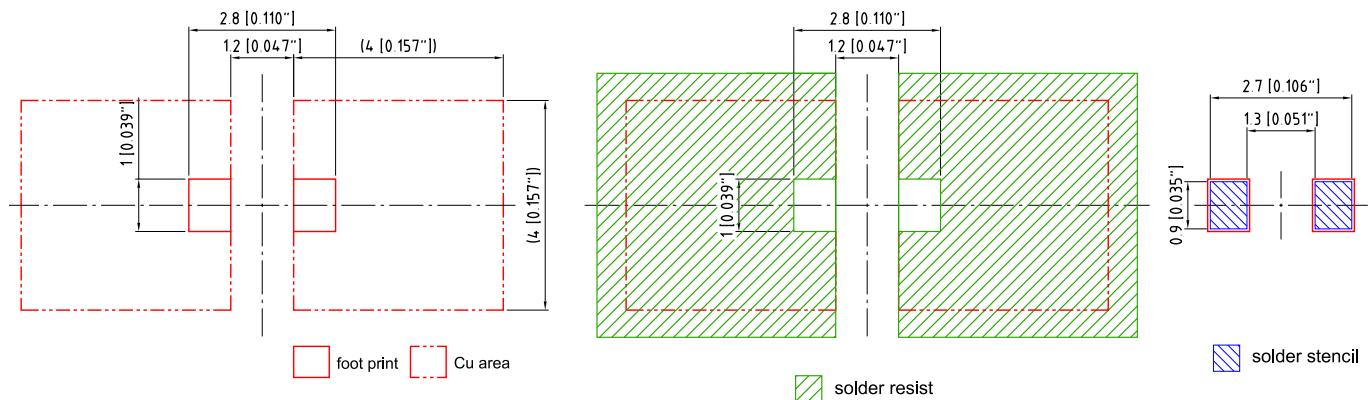
## Dimensional Drawing <sup>8)</sup>



**Approximate Weight:** 7.3 mg

**Package marking:** Anode

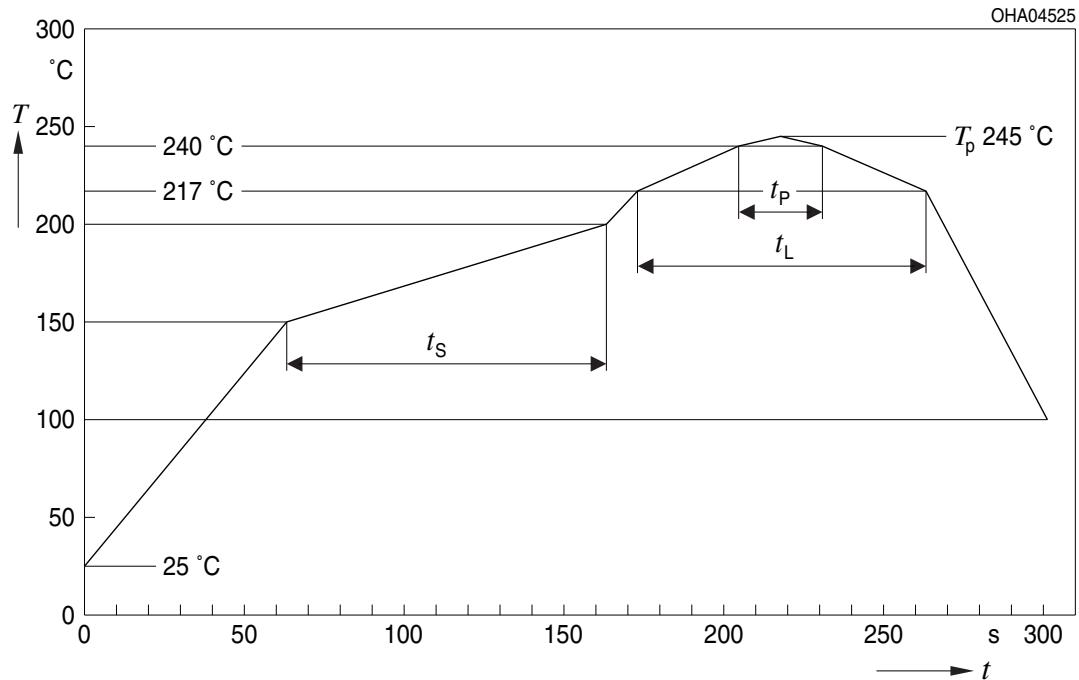
## Recommended Solder Pad<sup>8)</sup>



E062 3010.174-01

## Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

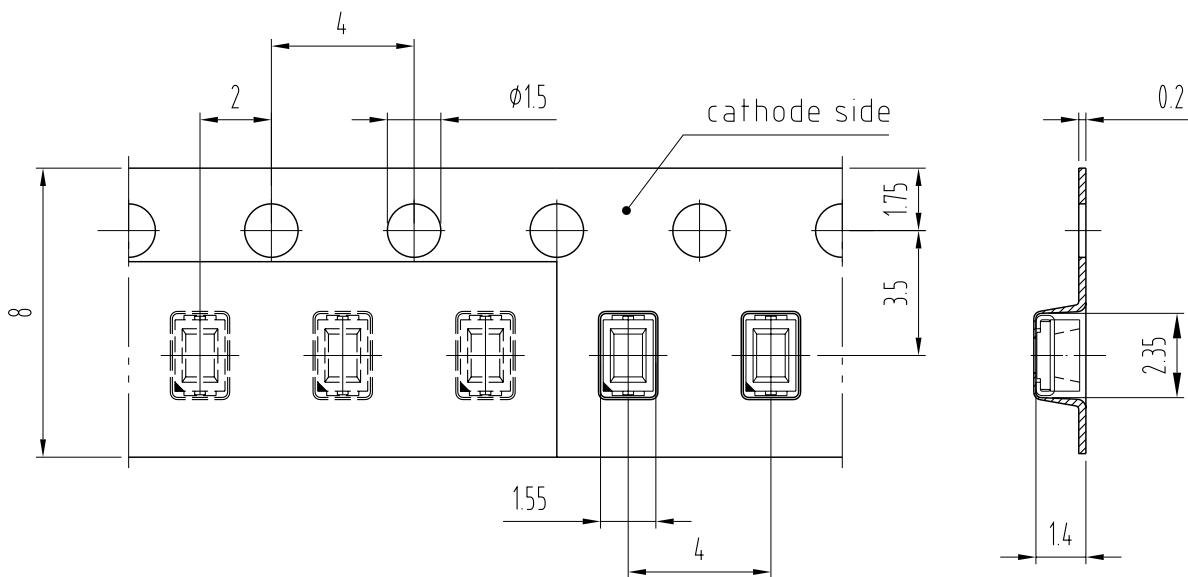


Profile Feature	Symbol	Pb-Free (SnAgCu) Assembly			Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time $t_s$ $T_{S\min}$ to $T_{S\max}$	$t_s$	60	100	120	s
Ramp-up rate to peak*) $T_{S\max}$ to $T_p$			2	3	K/s
Liquidus temperature	$T_L$		217		°C
Time above liquidus temperature	$t_L$		80	100	s
Peak temperature	$T_p$		245	260	°C
Time within 5 °C of the specified peak temperature $T_p - 5$ K	$t_p$	10	20	30	s
Ramp-down rate* $T_p$ to 100 °C			3	6	K/s
Time 25 °C to $T_p$				480	s

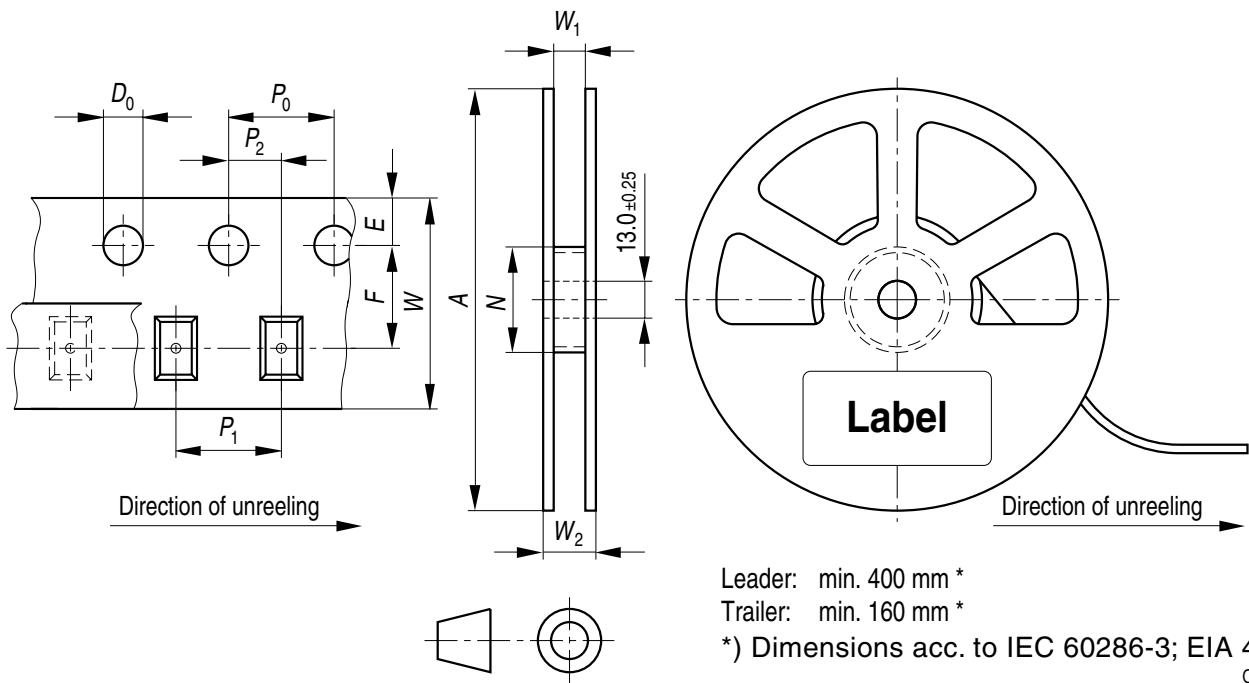
All temperatures refer to the center of the package, measured on the top of the component

\* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

## Taping <sup>8)</sup>

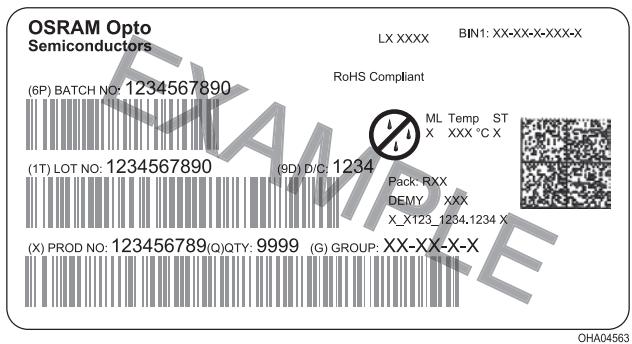


C63062-A3553-B2-02

**Tape and Reel** <sup>9)</sup>**Reel dimensions [mm]**

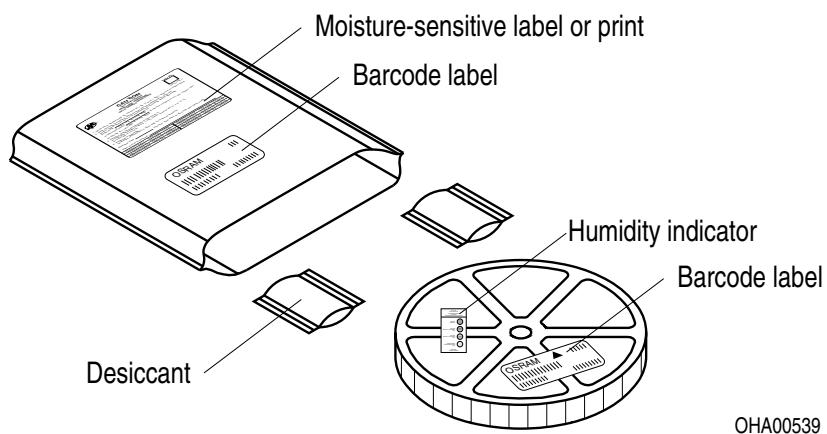
A	W	N <sub>min</sub>	W <sub>1</sub>	W <sub>2 max</sub>	Pieces per PU
180 mm	8 + 0.3 / - 0.1	60	8.4 + 2	14.4	3000
330 mm	8 + 0.3 / - 0.1	60	8.4 + 2	14.4	12000

## Barcode-Product-Label (BPL)



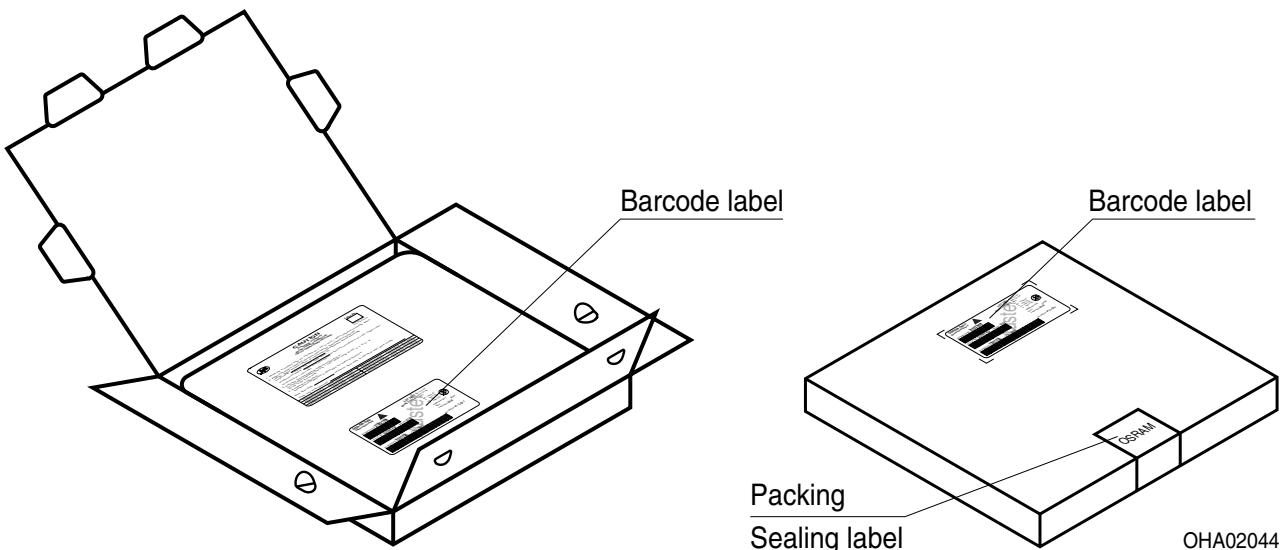
OHA04563

## Dry Packing Process and Materials <sup>8)</sup>



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according to JEDEC-STD-033.

## Transportation Packing and Materials <sup>8)</sup>



### Dimensions of transportation box in mm

Width	Length	Height
200 ± 5 mm	195 ± 5 mm	30 ± 5 mm
352 ± 5 mm	352 ± 5 mm	33 ± 5 mm

## Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the LED specified in this data sheet falls into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

For further application related informations please visit [www.osram-os.com/appnotes](http://www.osram-os.com/appnotes)

## Disclaimer

### Disclaimer

Language english will prevail in case of any discrepancies or deviations between the two language writings.

### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version in the OSRAM OS Webside.

### Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office.

By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

### Product safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

In case Buyer – or Customer supplied by Buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, Buyer and/or Customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and Buyer and /or Customer will analyze and coordinate the customer-specific request between OSRAM OS and Buyer and/or Customer.

## Glossary

- 1) **Radiant intensity:** Measured at a solid angle of  $\Omega = 0.01 \text{ sr}$
- 2) **Reverse Operation:** Reverse Operation of 10 hours is permissible in total. Continuous reverse operation is not allowed.
- 3) **Total radiant flux:** Measured with integrating sphere.
- 4) **Thermal resistance:** junction - ambient, mounted on PC-board (FR4), padsize 16 mm<sup>2</sup> each
- 5) **Thermal resistance:** junction - soldering point, of the device only, mounted on an ideal heatsink (e.g. metal block)
- 6) **Typical Values:** Due to the special conditions of the manufacturing processes of LED, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- 7) **Testing temperature:**  $T_A = 25^\circ\text{C}$
- 8) **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with  $\pm 0.1$  and dimensions are specified in mm.
- 9) **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

Published by OSRAM Opto Semiconductors GmbH EU RoHS and China RoHS compliant product  
Leibnizstraße 4, D-93055 Regensburg  
[www.osram-os.com](http://www.osram-os.com) © All Rights Reserved.



此产品符合欧盟 RoHS 指令的要求；  
按照中国的相关法规和标准，不含有毒有害物质或元素。

ООО "ЛайфЭлектроникс"

"LifeElectronics" LLC

ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 30101810900000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибуторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибуторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помочь разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)  
Email: org@lifeelectronics.ru